

APPENDIX

Claim 1:

1. (Amended) An integrated circuit including
 - a patterned copper layer,
 - a patterned aluminum layer,
 - a stud connection in an opening in a layer of material between a location on said patterned copper layer and a location on said patterned aluminum layer,
 - and
 - a liner in said opening and extending between said stud connection and said location on said patterned copper layer.